

# Confidentiality Request Letter

Reason for Amendment (current / obsolete)	Revision History		Approved Date
	From	To	
Initial Release (obsolete)	1.0	1.0	Nov-14-2006
Adding CFR 2.459 (obsolete)	1.0	2.0	August – 11 - 2008
Updated company template& Added text box (obsolete)	2.0	3.0	Jan-31-2012
Added IC confidentiality letter form (obsolete)	3.0	4.0	March-26-2015
Corrections to STC form. Added reference to KDB (current)	4.0	5.0	Nov 19 2015

DIATEC CORPORATION

2016/02/18

To:  
Federal Communications Commission  
Authorization and Evaluation Division  
7435 Oakland Mills Road  
Columbia, MD

Subject: **Permanent Confidentiality Request** for FCC ID: [XS8-CONV2TKL](#)

Pursuant to sections 0.457 and 0.459 of CFR 47, we respectfully request permanent confidential treatment of the following Exhibits accompanying this application as:

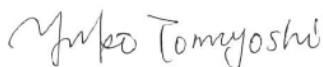
- [Block Diagram](#)
- [Schematics](#)
- [Operational Description](#)

The above materials contain trade secrets and proprietary information not customarily released to the public. The public disclosure of these materials may be harmful to the applicant and provide unjustified benefits to its competitors.

The applicant understands that disclosure of this application and all accompanying documentation will not be made before the date of the Grant for this application.

Sincerely,

Client's signature :



Tomiyoshi Yuko / Assistant Manager  
DIATEC CORPORATION  
4F Kairaku BLDG (SOTO-KANDA)6-5-4,Soto-kanda, Chiyoda-ku, TOKYO 101-0021, Japan

DIATEC CORPORATION

2016/02/18

To: Federal Communications Commission  
Office of Engineering and Technology  
Equipment Authorization Division  
7345 Oakland Mills Road  
Columbia, Maryland 21046

Subject: **Short Term Confidentiality Request** for FCC ID: [XS8-CONV2TKL](#)

To Whom It May Concern:

Pursuant to sections 0.457 and 0.459 of CFR 47, and to avoid premature release of sensitive information prior to marketing or release of the product to the public, the applicant requests the following documents contained in this certification application be temporarily withheld from public disclosure for an initial period of 45  or 180  days; or for a specified date of  /  /  (please check one). not to exceed 180 days from the Grant Date. See KDB 726920..

- [User Manual](#)
- [Internal Photos](#)
- [External Photo](#)
- [Test Setup photos](#)

The above materials contain trade secrets and proprietary information not customarily released to the public. The public disclosure of these materials may be harmful to the applicant and provide unjustified benefits to its competitors.

Sincerely,

Client's signature : 

Tomiyoshi Yuko / Assistant Manager  
DIATEC CORPORATION  
4F Kairaku BLDG (SOTO-KANDA)6-5-4,Soto-kanda, Chiyoda-ku, TOKYO 101-0021, Japan